

OLED Manufacturing and Integration Challenges

Jeff Spindler, OLEDWorks

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Complementary Solid-State Light Sources

LED: Extremely intense point source of light
Most efficient at cooler CCTs

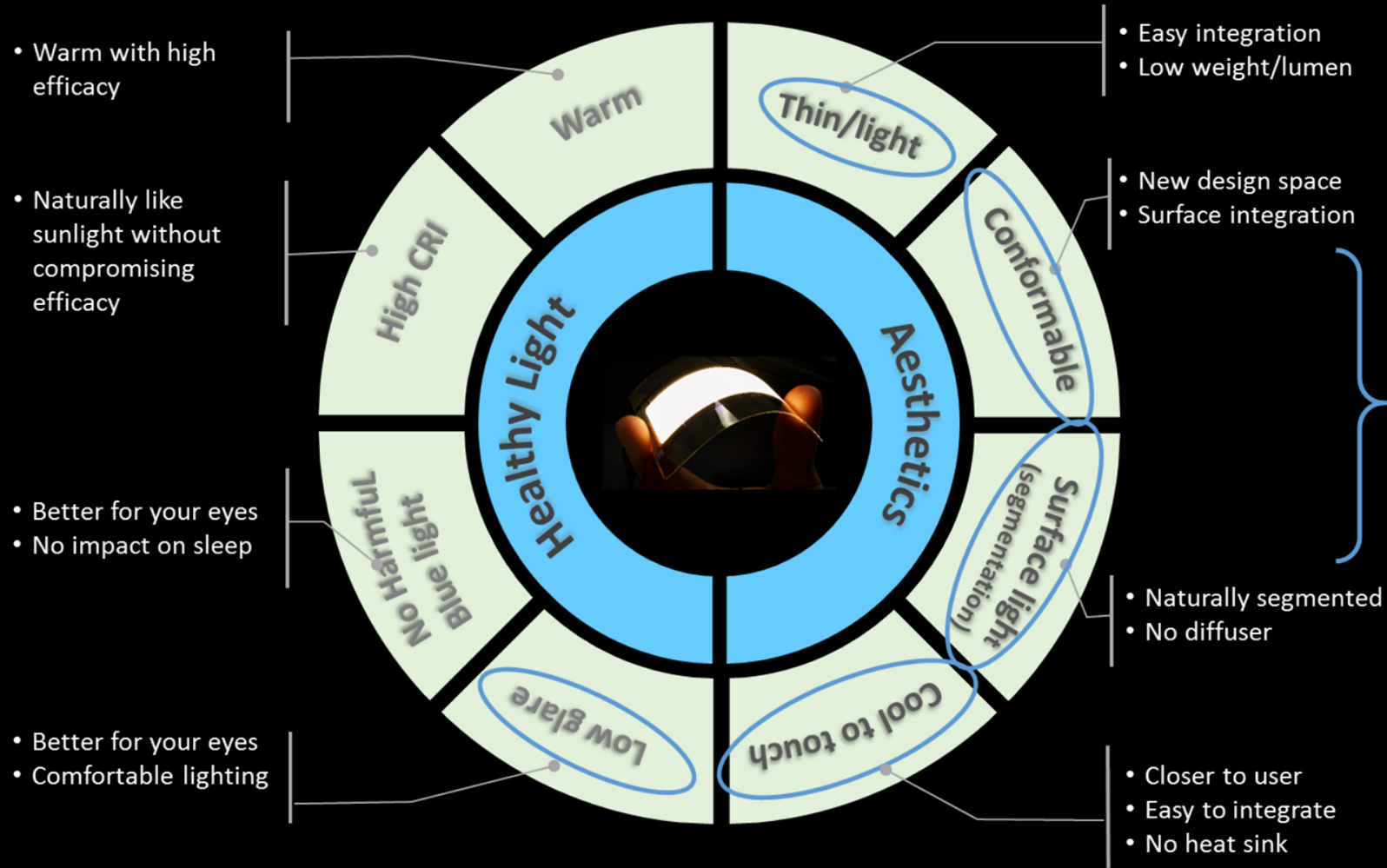


OLED: Naturally diffuse area light source
Most efficient at warmer CCTs

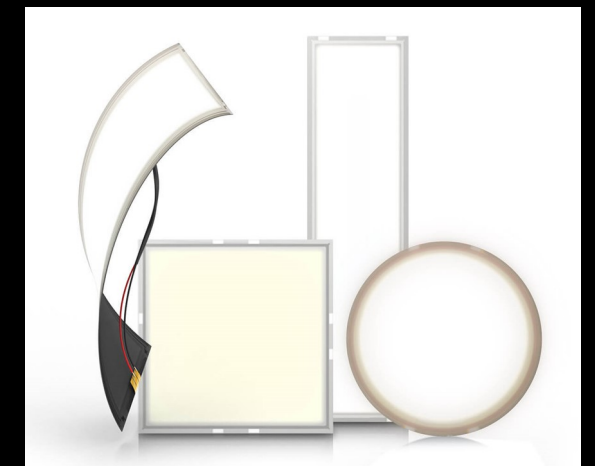


- Fundamentally different by nature
- Greatest energy efficiency and human benefits realized when used in a complementary manner: “Lighting application efficiency”

OLED Benefits



Lighting panels or tiles that are thin, lightweight, cool to the touch, both rigid and bendable forms

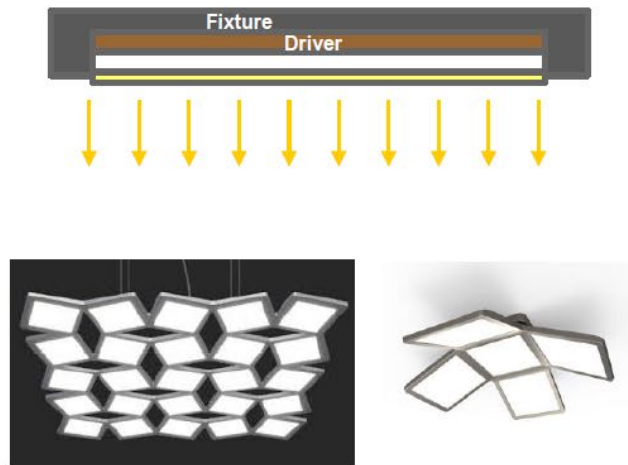


Luminaire Integration

OLED, True Surface Light

In addition to OLED panel, luminaire needs

- Driver
- Fixture

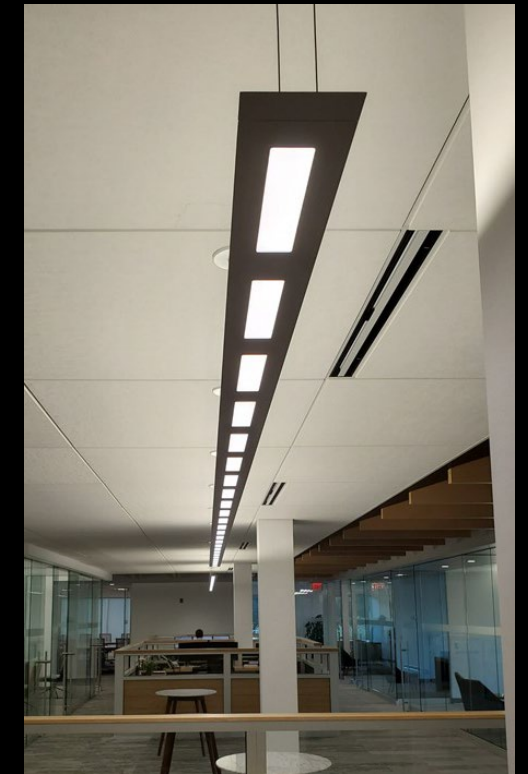
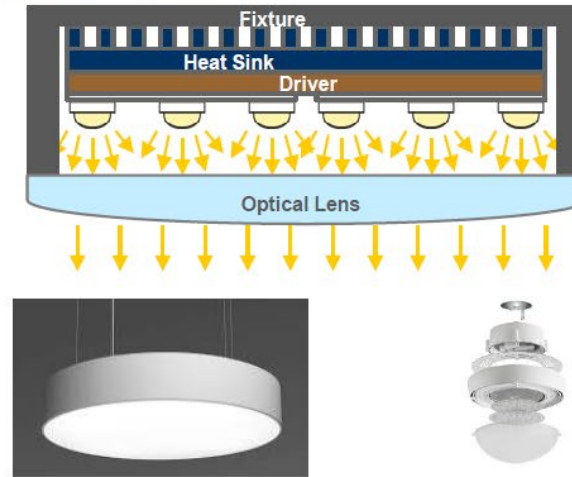


D. Chowdhury, 2018 OLEDs World Summit

LED, Point Light

In addition to LED packages, luminaire needs

- Driver
- Heat Sink
- Fixture
- Optical lens/diffuser



- Simpler integration for OLEDs
- Hybrid LED+OLED fixtures can be very efficient, beautiful, and cost-effective
- Integrated fixture cost is similar even with higher initial cost of OLED panels

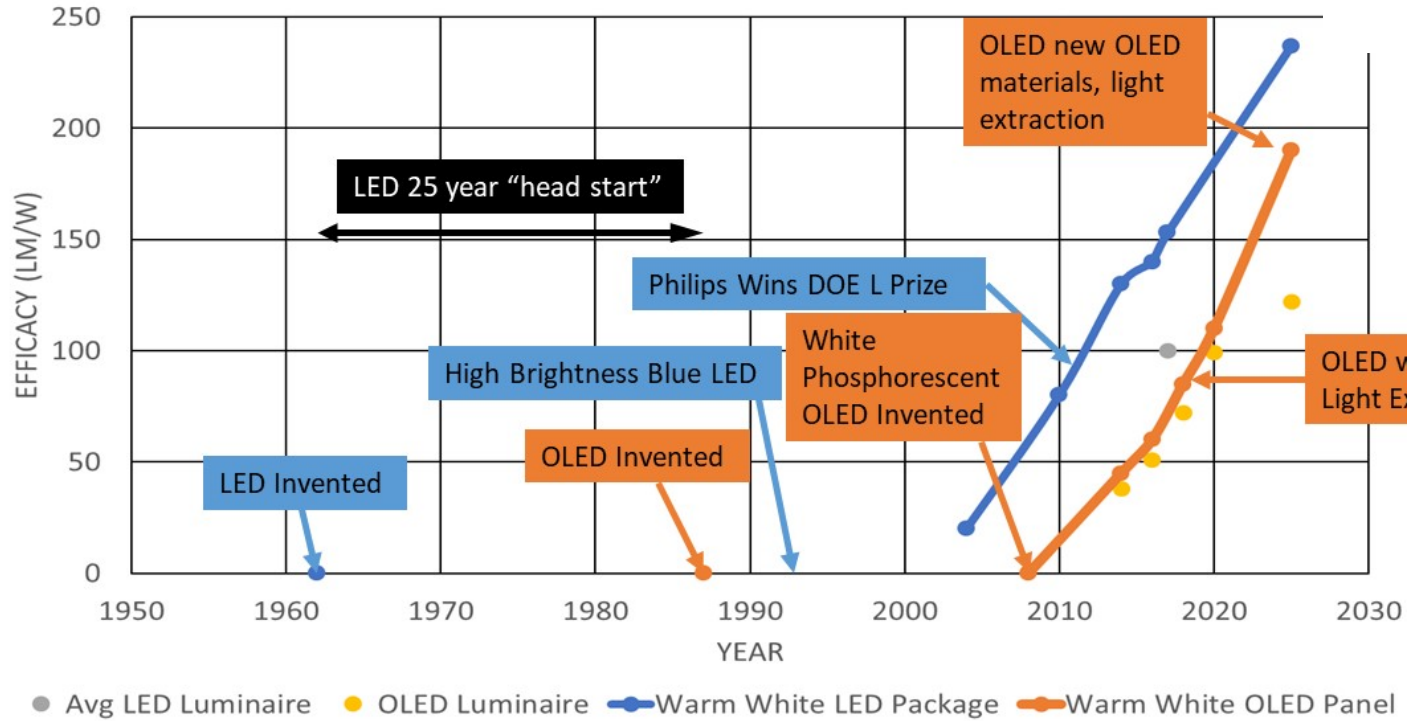
Efficacy

Table 3.8 Breakdown of warm-white OLED luminaire efficiency with historical and targeted performance projections.

Metric	2019	2022	2025	2035
Panel Efficacy [†] (lm/W)	85	120	155	180
Optical Efficiency of Luminaire	100%	100%	90%†	90%†
Efficiency of Driver	88%	90%	92%	95%
Total Efficiency from Device to Luminaire	88%	90%	81%	86%
Resulting Luminaire Efficacy* (lm/W)	72	108	128	154

Notes:
 * Efficacy projections assume CRI >90, CCT 3000 K
 † Losses representing possible use of beam shaping optics

Efficacy Trajectory



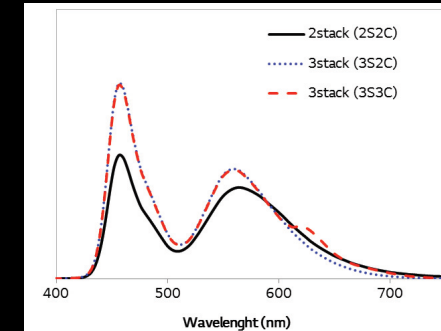
2019 DOE SSL R&D Opportunities

Manufacturing

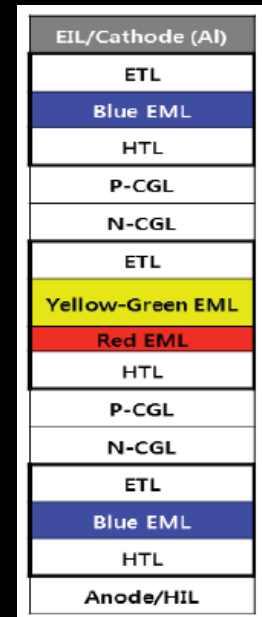
- LEDs manufactured using semiconductor IC processing techniques
 - 2"-6" Wafer level processing
 - MOCVD is key process
 - Dicing into individual chips or dies
 - Packaging – single chips or multi-chip modules (MCM, COB, etc)
- OLEDs manufactured using flat panel display processing techniques
 - Gen2 (370x470mm) to Gen5 (1100x1300mm) glass substrate processing
 - Organic deposition (VTE) is key process
 - Singulation into individual panels
 - Backend finishing – EEL, electrical connection

Multi-Stack White OLEDs

- Makes higher brightness and long lifetime possible
- Up to 6-stack OLEDs with 40+ organic layers

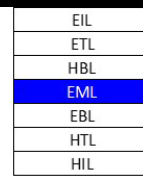
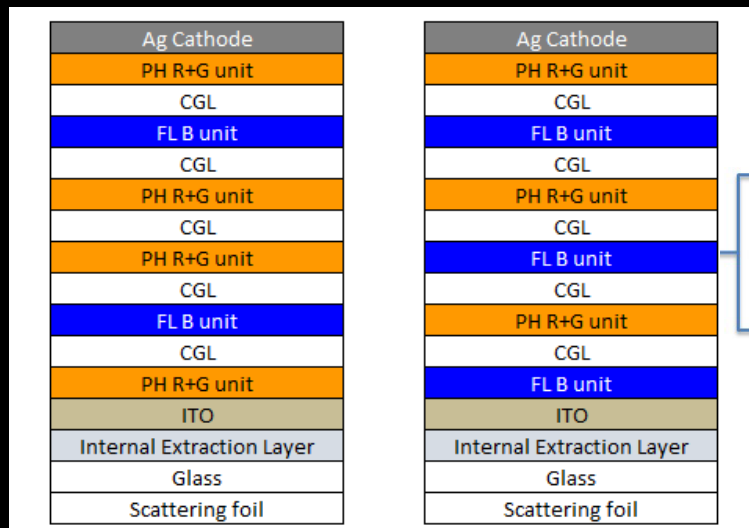


LG Display uses 3-stack white OLED for OLED TV (IDW 2018)

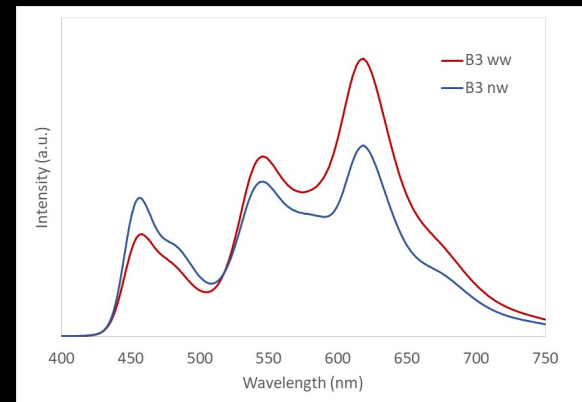


Warm white (3000K)

Neutral white (4000K)



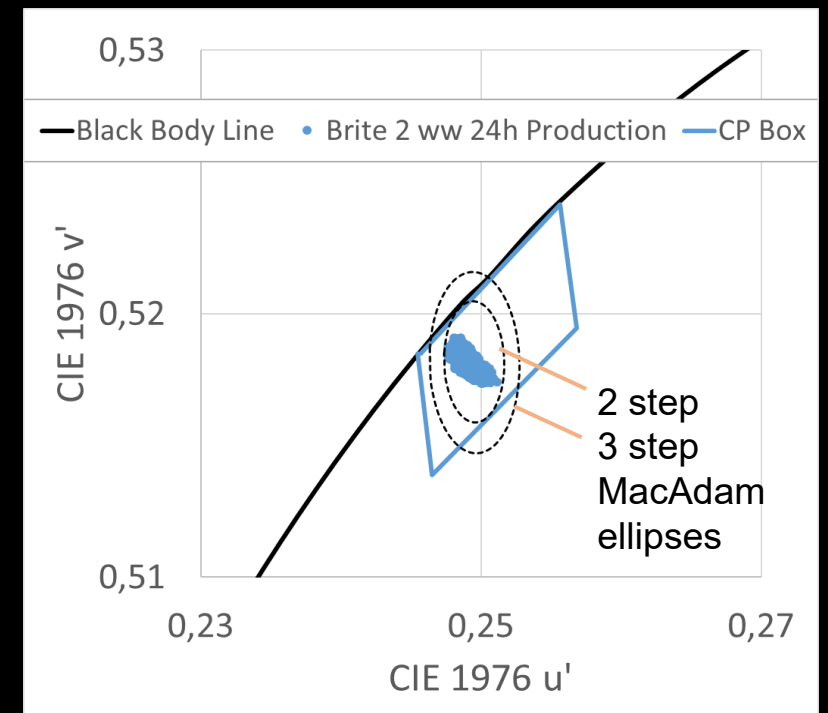
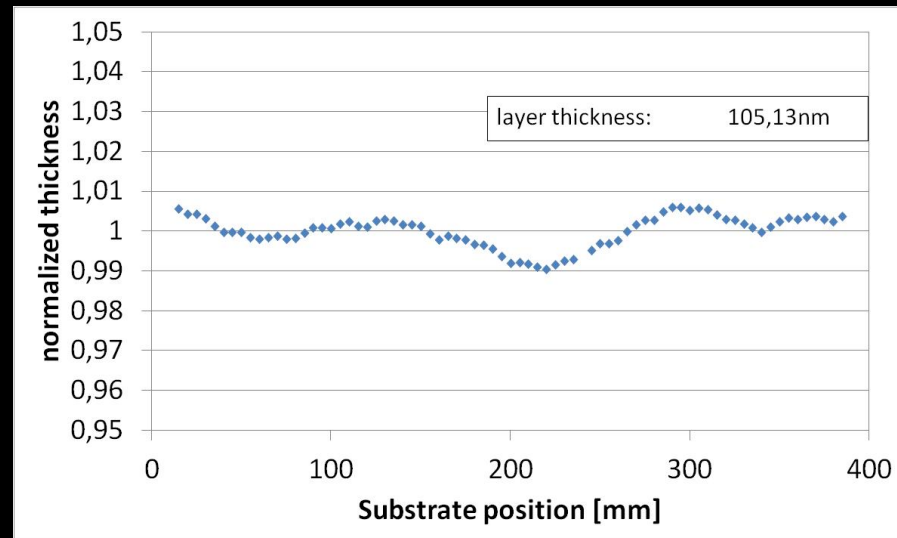
Each 'unit' or stack consists of multiple layers



3000K Warm White (ww)	Standard Brightness (3000 cd/m ²)			High Brightness (8300 cd/m ²)		
	100 lumens			300 lumens		
Metric	B1	B2	B3	B1	B2	B3
Efficacy (lm/W)	46	63	85	42	57	75
CRI	80	90	90	80	90	90
R9	0	70	55	0	70	55
LT70 (kh)	50	75	100	10	15	30

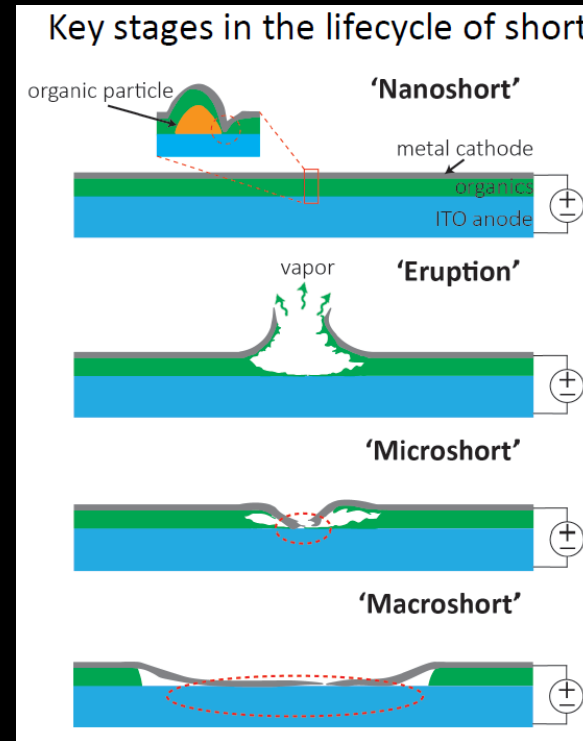
OLED Manufacturing

- Precise control of organic layer thickness (+/- 1%) required to maintain color and product quality
- Maintain constant deposition rates for 40+ sources over time, within batch and run-to-run



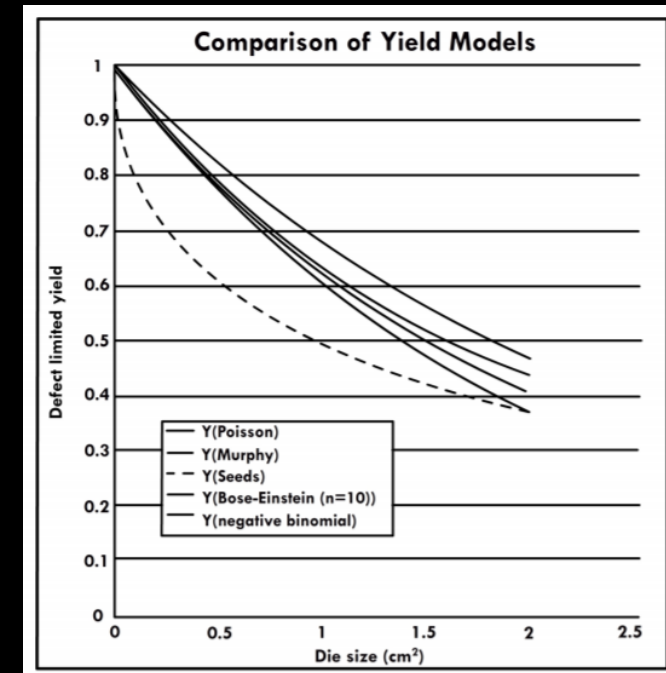
OLED Yield Considerations

- Large area device $> 100\text{cm}^2$ which is susceptible to particle defects and electrical leakage/shorts
- Need short tolerant structures and techniques for high yield
 - Smooth surfaces $<5\text{-}10\text{nm RMS}$, no abrupt changes in height
 - Thicker organic stacks
 - Routine cleaning of OLED deposition chamber, masks, etc.
 - Electrical short reduction techniques
 - Fuse-like layers, thin dielectric layers

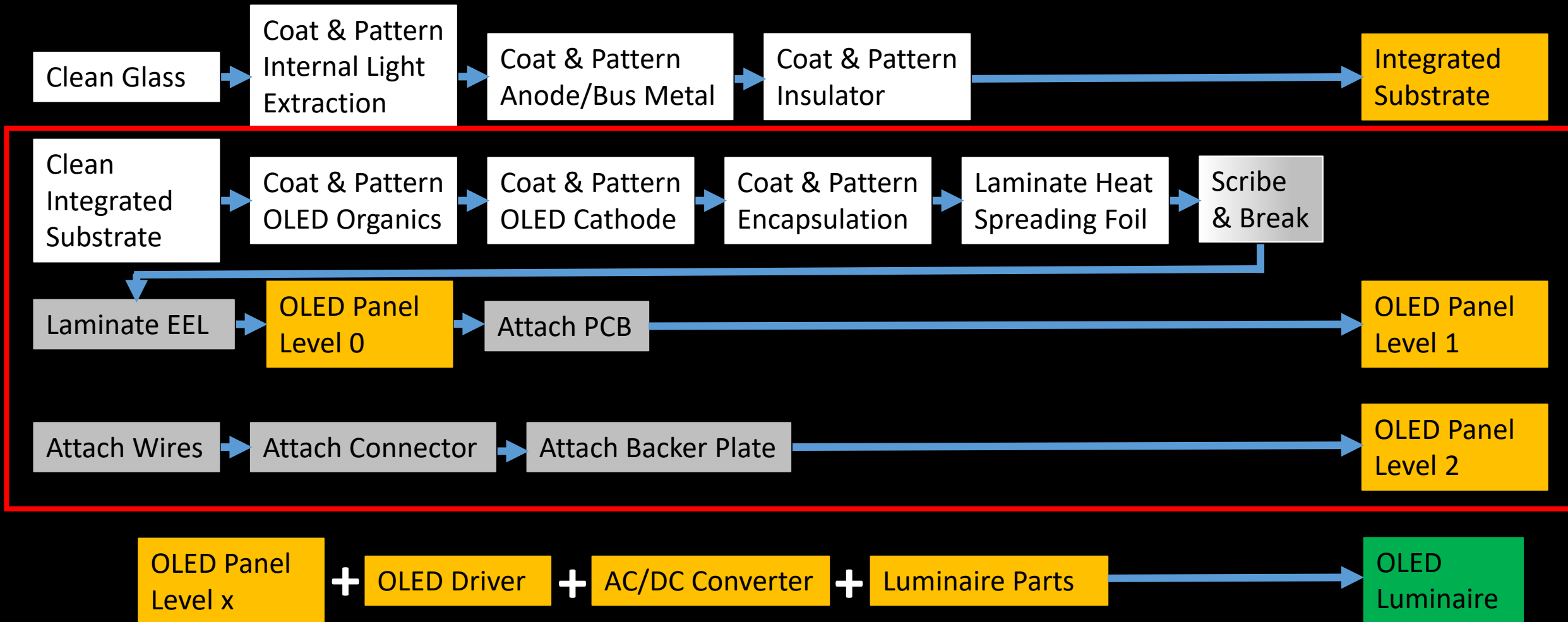


PSU DOE Project "Nature of Catastrophic Shorts in OLED Lighting", N. Giebink et al

Yield models for semiconductor ICs predict OLED yield should be ZERO



OLED Process Flow



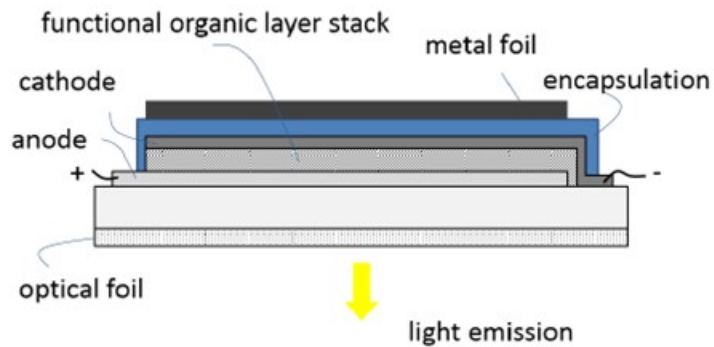
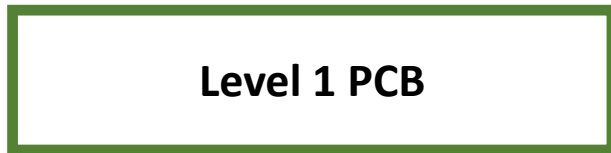
OLED Panel Integration

Level 0

Bare OLED Panel

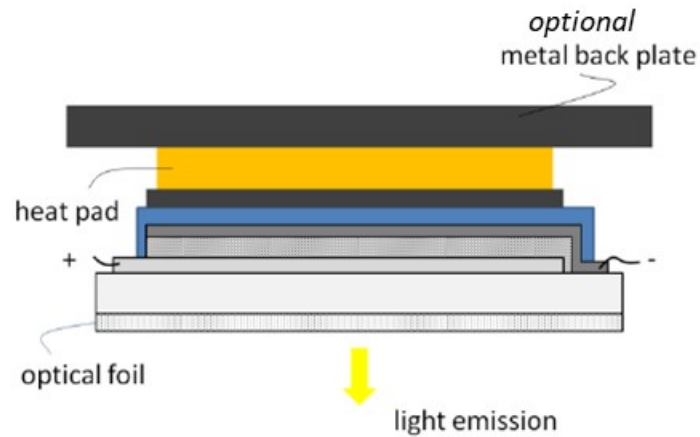


Level 1 PCB

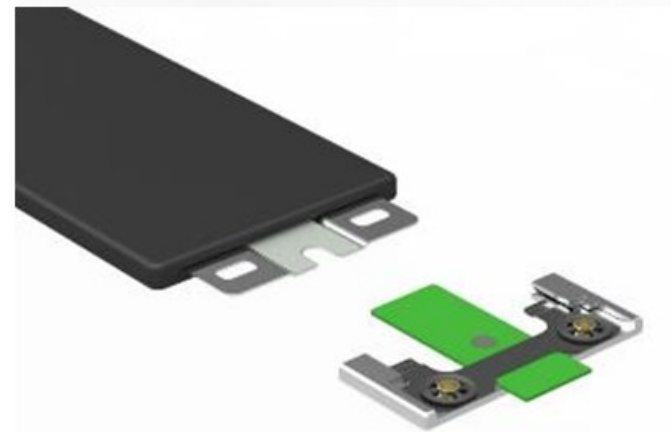
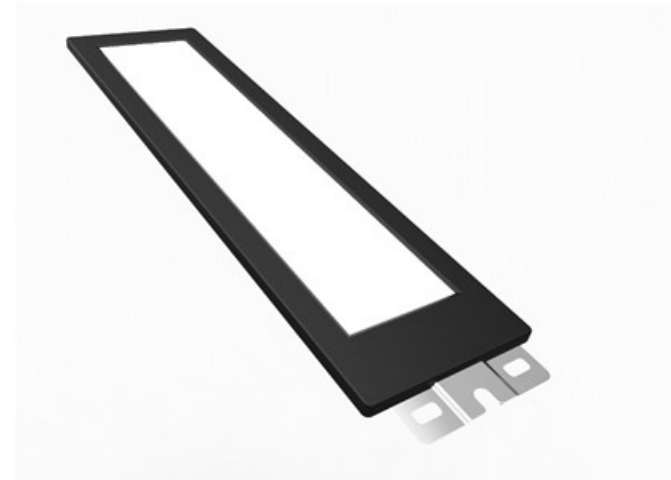


Level 2

OLED Panel + Back Plate + Connector

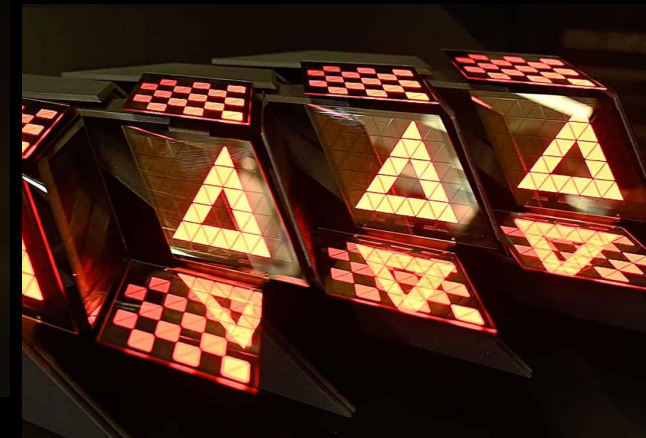
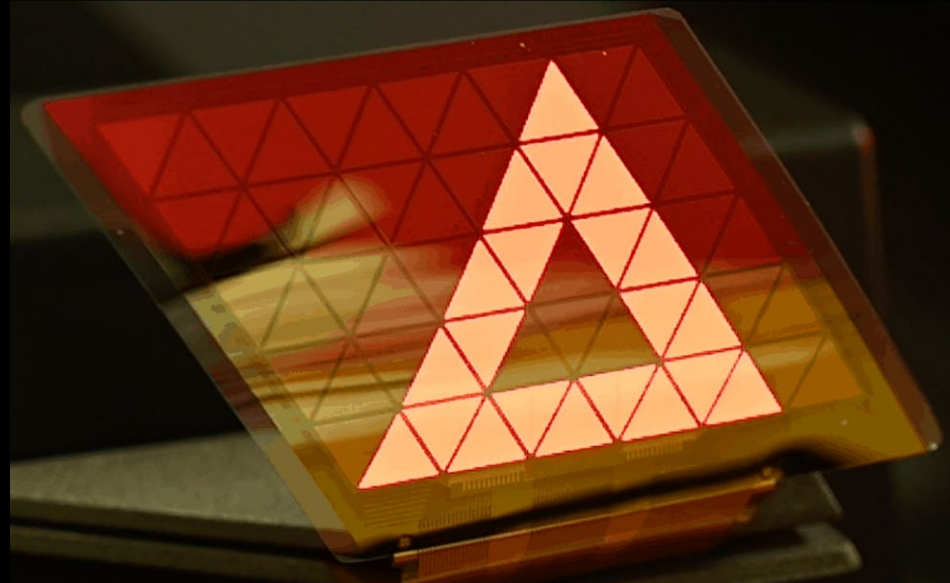


OLED Panel + Driver + Housing

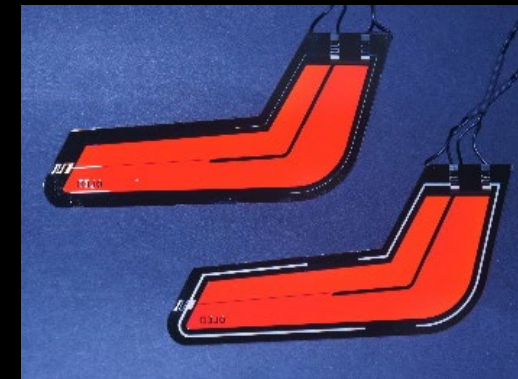


OLEDWorks Keuka OLED Module

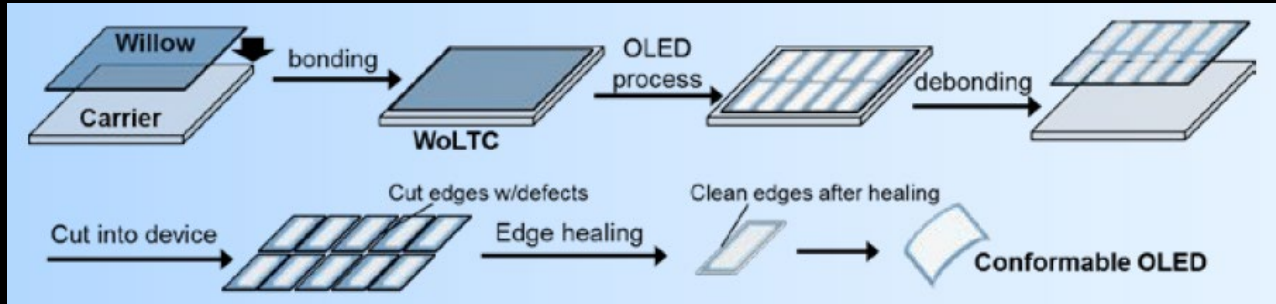
OLED Panel Integration - Automotive



- Automotive panels include metallization on the substrate and flexible printed circuit (FPC)
- FPC connects to PCB containing driving electronics
- Control of individual lit segments, like a display
- Mirror-like 'chrome' finish – no light extraction films



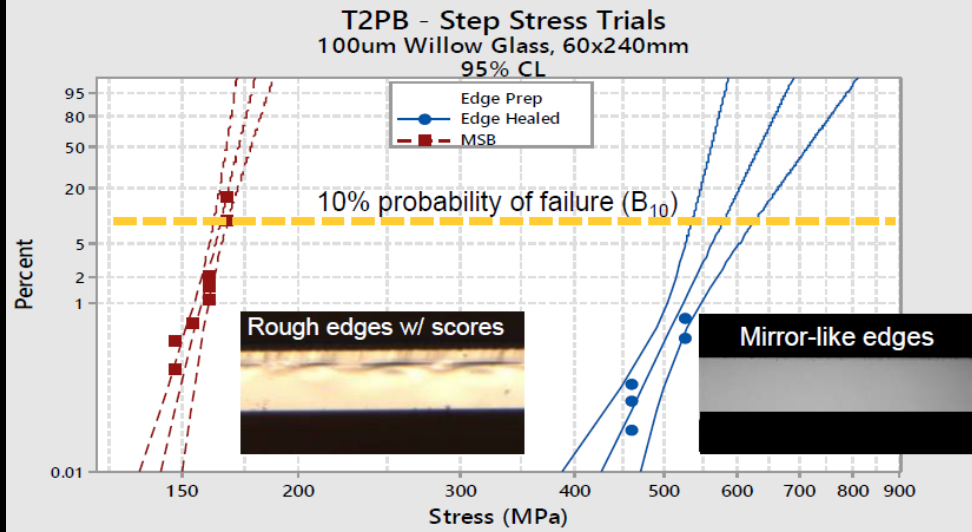
Bendable OLED Manufacturing



CORNING

D. Chowdhury, OLEDs World Summit 2018

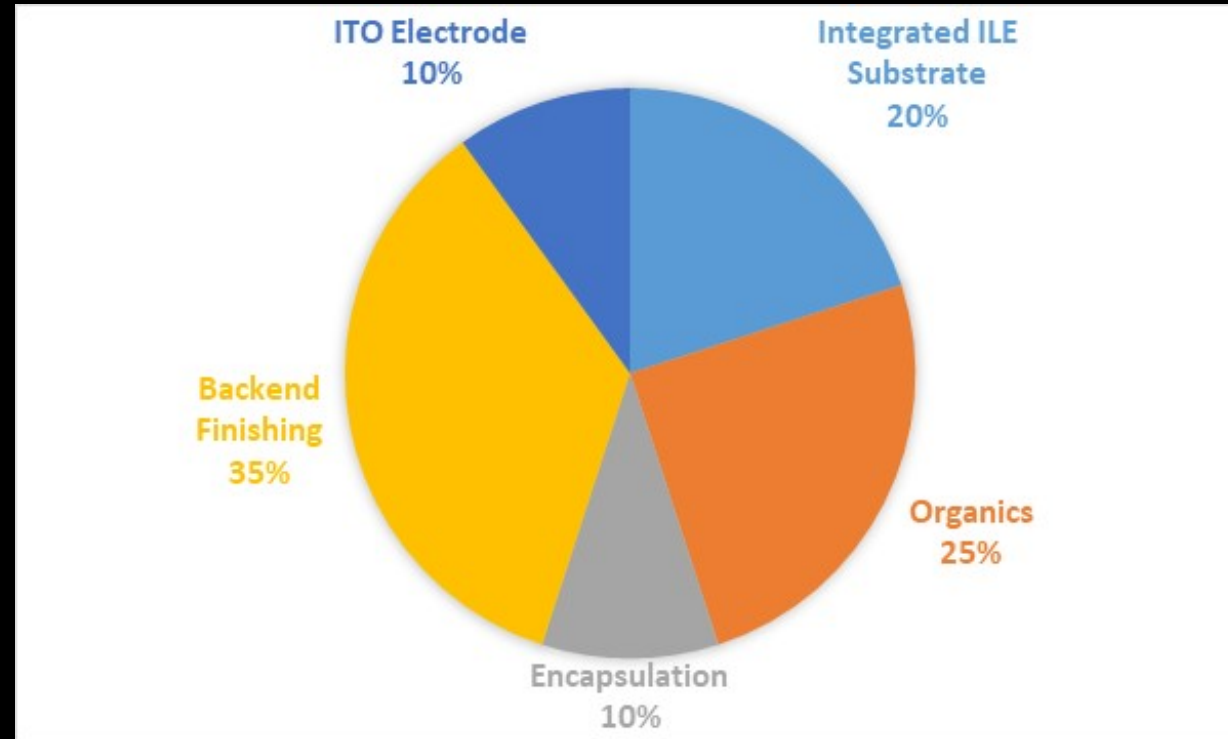
0.1mm glass in Two Point Bend Evaluations
(before and after edge healing)



Bendable OLED Panel Integration



Current BOM Breakdown



Cost Reduction Needs

- Integrated Substrates
 - Higher throughput manufacturing for ILE, anode, insulator
 - Additive manufacturing – printing, etc.
 - ITO alternate
 - Vertical Integration with panel manufacturer (reduce substrate shipping costs)
- OLED Deposition
 - Higher throughput to reduce TACT
 - Thermally stable organic materials
 - VTE alternate? OVPD, OVJP, solution coating/printing, etc.
 - Better organic material utilization
 - Maskless patterning/deposition
- Encapsulation
 - All inorganic? Must be low capital and high throughput
 - PECVD alternate
 - Lamination type
- Backend Finishing
 - Eliminate EEL (external extraction film)
 - Lower cost electrical connection
 - Full automation

- Need lower capital cost options for all areas
- Need to consider R2R or R2S manufacturing for the future

Future Trends

- Higher brightness / more lumens per panel
 - Automotive functions may require $> 20,000 \text{ cd/m}^2$ (deep red)
 - Horticulture – white or tuned spectrum
 - General lighting – commercial, outdoor, warehouse, etc. - reduce cost per lumen further
- Larger size OLED panels up to $1,000 \text{ cm}^2$ (0.1 m^2)
 - General lighting, machine vision
- Spectral tuning for health, productivity, comfort

R&D needs:

- Better extraction efficiency – get the light out
- Light extraction that maintains mirror finish (no haze)
- Multi-stack OLEDs – improved CGLs, lower voltage per stack
- Improved blue emitters
- More conductive TCOs $\sim 1 \text{ ohm/sq}$
- Heat management, thermal tolerance
- Yield management strategies, defect tolerance